

## 1.0 SCOPE

This specification covers Insulation Displacement Terminal (IDT) for ribbon cable on 1.00 mm centers with single-beam contact terminal connection for 0.50 mm square pins on dual row 2.00mm grid.

#### 2.0 PRODUCT DESCRIPTION

This specification covers the following Product Series:

2.1

| Product Name                      | Part Numbers      |  |
|-----------------------------------|-------------------|--|
| 2.00 mm "Milli-Grid" Dual Row IDT | 87568-**** Series |  |

- 2.2 See the appropriate sales drawings for more information on dimensions, materials, plating and markings.
- 2.3 The connector is supplied to the customer with the terminals pre-assembled in a lower housing and pre-loaded with an upper housing. The ribbon cable may be inserted into the pre-loaded upper housing and assembled to the lower housing with the use of hand tool or bench press.
- 2.4 The ribbon cable connector will mate with any Milli-Grid header with a mating pin length between 2.50mm to 4.20mm.
- 2.5 The connector accepts 1.00mm pitch AWG #26 & 28 stranded flat ribbon cable.
- 2.6 SAFETY AGENCY APPROVAL

| UL FILE NUMBER:  | E29179   |
|------------------|----------|
| CSA FILE NUMBER: | LR 19980 |

#### 3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

The following documents form part of this specification to the extent specified herewith. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In the event of conflict between the requirements of this specification and reference documents, this specification shall take precedence.

| MIL-STD-202  | Test methods for Electronic and Electrical component parts. |
|--------------|---|
| MIL-STD-1344 | Test methods for Electrical Connectors.                     |

| REVISION:<br>A1 | ECR/ECN INFORMATION:<br>EC No: <b>121915</b><br>DATE: <b>2010/10/10</b> | 2 MM "MILLI GRID" DUAL ROW<br>IDT RECEPTACLE |  | <u>SHEET No.</u><br><b>1</b> of <b>4</b> |
|-----------------|---|--|--|--|
|                 |   | OVED BY:<br>HLIM                             |  |  |
|                 | TEMPLATE FILENAME: PRODUCT. SPECISIZE, 44/V, 1) DOC                     |  |  |  |



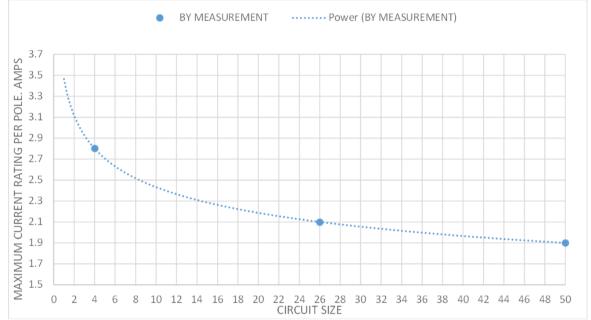
## **PRODUCT SPECIFICATION**

#### **4.0 RATINGS**

#### 4.1 Current :

Current rating is application dependent and each application should be evaluated by the end user for compliance to specific safety agency requirements. The ratings listed in the chart below are per Molex test method based on a 30° C maximum temperature rise over ambient temperature and are provided as a guideline. Appropriate de-rating is required based on circuit size, ambient temperature, copper trace size on the PCB, AWG WIRE, gross heating from adjacent modules/components and other factors that influence connector performance. Wire size, insulation thickness, stranding, tin coated or bare copper, wire length & crimp quality are other factors that influence current rating.

Wire to Board (87568 & 87832 Series)



Voltage : 125 Volts AC (RMS) / DC Max 4.2

Temperature Range : -45°C to + 85 °C 4.3

#### **5.0 PERFORMANCE**

|     | 5.1 Mechanical Performance       |  |   |                                |                       |  |
|-----|----------------------------------|--|---|--------------------------------|-----------------------|--|
|     |                                  | ITEM   | TEST COND   | REQUIREMENT                    |                       |  |
|     | 5.1.1                            | Cable Retention<br>With out Srain<br>Relief (Upper<br>Housing Retention) | An axial force is applied to the cable at the<br>rate of 25.4 mm per minute till the upper<br>housing is removed from the lower housing |                                | 0.25 kgf min. per ckt |  |
|     | <u>ISION:</u>                    | ECR/ECN INFORMATION:<br>EC No: <b>121915</b><br>DATE: <b>2010/10/10</b>  |   | LLI GRID" DUA<br>RECEPTACLE    | -                     | <u>SHEET No.</u><br><b>2</b> of <b>4</b> |
| DOC | DOCUMENT NUMBER:<br>PS-87568-004 |  | CREATED / REVISED BY:<br>SCHEONG  | <u>CHECKED BY:</u><br>GMENARLY |                       | OVED BY:<br>K <b>HLIM</b>                |

TEMPLATE FILENAME: PRODUCT\_SPEC[SIZE\_A4](V.1).DOC

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# PRODUCT SPECIFICATION

| 5.1.2 | Terminal Retention<br>Force                       | Dislodge the terminal from the housing at the rate of 25.4 mm per minute.  | 0.20 kgf min. per<br>terminal   |
|-------|---|--|---|
| 5.1.3 | Engagement /<br>Disengagement<br>Forces (per ckt) | SQ pin 0.52 +/- 0.005 mm (Engagement)<br>SQ pin 0.48 +/- 0.005 mm (Disengagement)<br>at the rate of 25.4 mm per minute.            | Engaging: 200 gf max.<br>Disengaging: 10 gf<br>min.                     |
| 5.1.4 | Mate & Unmate<br>Force                            | Mate & Unmate connector with applicable shrouded headers at the rate of 25.4 mm/min.   | Mate force: 200 g per<br>ckt max.<br>Unmate force:<br>40 g per ckt min. |
| 5.1.5 | Strain Relief<br>Retention<br>(Optional)          | An axial force is applied to the cable at the rate of 25.4 mm per minute till the strain relief is removed from the lower housing. | 7.5 kgf min.  |
| 5.1.6 | Durability  | 100 cycles of mating and unmating at a rate of 600 cycles per hour   | Contact Resistance: 30 m $\Omega$ max.                                  |

## 5.2 Electrical Performance:

|       | ITEM                     | TEST CONDITION   | REQUIREMENT                   |
|-------|--------------------------|--|-------------------------------|
| 5.2.1 | Temperature Rise         | Mate connectors and measure the temperature rise of contact when the maximum DC rated current is passed.                           | 30 °C max. rise over ambient. |
| 5.2.2 | Insulation<br>Resistance | Measurements taken between adjacent<br>contacts of unmated connectors where<br>500V DC is applied.<br>(MIL-STD-1344A, Method 3003) | 5,000 M $\Omega$ min.         |
| 5.2.3 | Dielectric Strength      | Unmated samples subjected to 500VG<br>AC rms for 5 seconds. between VAL<br>adjacent contacts<br>(MIL-STD-1344A, Method 300P)       | No breakdown.                 |
| 5.2.4 | Contact Resistance       | Mated samples subjected to 20 mV<br>open circuit & 10mA max.<br>(MIL-STD-1344A, Method 3004)                                       | $30 \text{ m}\Omega$ max.     |

|                  | TEMPLATE FILENAME: PRODUCT_SPEC[SIZE_A4](V.1).DOC |  |             |                      |          |
|------------------|---|--|-------------|----------------------|----------|
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| DOCUMENT NUMBER: |   | CREATED / REVISED BY:  | CHECKED BY: | APPR                 | OVED BY: |
|                  | <u>DATE:</u> 2010/10/10                           |  |             | <b>3</b> 01 <b>4</b> |          |
| A1               | <u>EC No:</u> 121915                              | <sup>TITLE:</sup> 2 MM "MILLI GRID" DUAL ROW<br>IDT RECEPTACLE |             | <b>3</b> of <b>4</b> |          |
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#### **Environmental Performance** 5.3

|       | ITEM                | TEST CONDITION  | REQUIREMENT   |
|-------|---------------------|---|---|
| 5.3.1 | Humidity            | Temperature : 40 °C<br>Relative Humidity : 90-95%<br>Duration : 240 hrs<br>(MIL-STD-1344A, Method 1002.2, Type 1,<br>Condition A) | No Damage<br>Contact Resistance: $30 \text{ m}\Omega$ max.<br>Insulation Resistance: $5000 \text{ M}\Omega$<br>min.<br>Dielectric Strength: No Break<br>Down. |
| 5.3.2 | Thermal Shock       | 30 minutes of -55 °C and 30 minutes of 85 °C<br>for 5 cycles<br>(MIL-STD-1344A, Method 1003.1, Condition A)                       | Contact Resistance: 30 m $\Omega$ max.<br>No Damage.  |
| 5.3.3 | Temperature<br>Life | Temperature: 105 +/- 2 °C for 250 hours.<br>(MIL-STD-1344A, Method 1005.1, Condition 4)   | Contact Resistance: 30 m $\Omega$ max. No Damage.   |
| 5.3.4 | Salt Spray          | Temperature: 35 +/- 2 °C<br>Solution : 5 +/- 1%<br>Spray Time : 48 hours<br>(MIL-STD-202F, Method 101D, Condition B)              | Contact Resistance: 30 m $\Omega$ max.  |
| 5.3.5 | Vibration           | 1.52mm peak to peak,10-55-10 Hz traversed in 1 min, each 1 hour fro X,Y, & Z directions.  | Discontinuity 1 $\mu$ sec max.<br>Contact Resistance: 30 m $\Omega$ max.  |
| 5.3.6 | Mechanical<br>Shock | 100 G's 6msm, half sine with 3 shocks<br>in each X, Y & Z axis.   | Discontinuity 1 $\mu$ sec max.<br>Contact Resistance: 30 m $\Omega$ max.  |

#### 6.0 PACKAGING

Parts shall be packaged in Tray to protect against damage during handling, transit, and storage.

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|---|-------------------------|----------------------------|-------------|----------------------|----------|
| A1  | <u>EC No:</u> 121915    |                            |             | <b>4</b> of <b>4</b> |          |
|   | <u>DATE:</u> 2010/10/10 |                            |             | - 0 -                |          |
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